

REC

06-07-2001

COVERED SHEET

Tab settings ▢ ▢ ▢ ▼

To the Honorable Commissioner of P.

101740899

ached original documents or copy thereof.

1. Name of conveying party(ies):

Shinsaku TANAKA
Takashi YAMANAKA

05/30/01

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: TANASHIN DENKI CO., LTD.

Internal Address: _____

Street Address: 8-19-20, Fukazawa,
Setagaya-ku, Tokyo, Japan

City: _____ State: _____ ZIP: _____

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

- Assignment Merger
- Security Agreement Change of Name
- Other _____

Execution Date: 5/24/01 & 5/24/01

4. Application number(s) or patent number(s):

09/866720

If this document is being filed together with a new application, the execution date of the application is: 5/24/01

A. Patent Application No.(s)

B. Patent No.(s)

06/04/2001 MBELETE1 00000039 09866720

02 FC:581

40.00 OP

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Felix J. D'Ambrosio

Internal Address: P.O. Box 2266 Eads Station
Arlington, VA 22202

Street Address: 2001 Jefferson Davis Hwy.

Suite 1002

City: Arlington State: VA ZIP: 22202

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41).....\$ 40.00

- Enclosed
- Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Felix J. D'Ambrosio

Name of Person Signing

Felix J. D'Ambrosio
Signature

May 30, 2001

Date

Total number of pages including cover sheet, attachments, and document:

2

ASSIGNMENT

In consideration of One Dollar (\$1.00), and other good and valuable consideration, the receipt of which is hereby acknowledged, we, the undersigned,

(1) Shinsaku TANAKA

(2) Takashi YAMANAKA

3-13-24, Seijo, Setagaya-ku,
Tokyo, Japan

1-2-13, Noge, Setagaya-ku,
Tokyo, Japan

Hereby sell, assign and transfer to TANASHIN DENKI CO., LTD., a corporation of Japan, having a place of business at 8-19-20, Fukazawa, Setagaya-ku, Tokyo, Japan, its successors, assigns and legal representatives, the entire right, title and interest for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewith and is entitled:

DISC EJECTING APPARATUS, and in and to said application and all divisional, continuing, substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be issued in the United States and all foreign countries on said improvements;

Agree that said Assignee may apply for and receive Letters Patent for said improvements in its own name; and that, when requested, without charge to but at the expense of said Assignee, its successors, assigns and legal representatives, to carry out in good faith the intent and purpose of this assignment, the undersigned will execute all divisional, continuing, substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all applications for patents and all patents on said improvements, in said Assignee, its successors, assigns and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date..... May 24, 2001

By.....  (L.S.)
Shinsaku TANAKA

Date..... May 24, 2001

By.....  (L.S.)
Takashi YAMANAKA

Date.....

By..... (L.S.)